



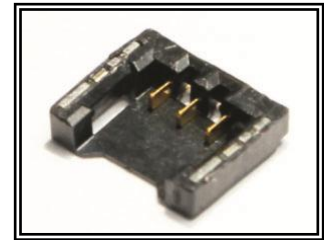
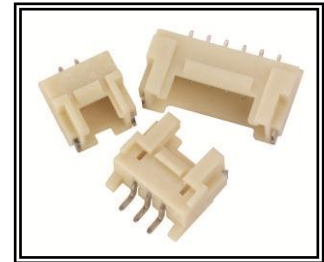
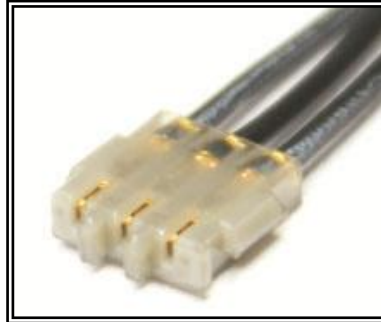
Wire to Board Connector

Technical Specs

Pitch: 0.6, 0.8,
1.0, 1.25, 1.5,
2.0, 2.5, 2.54 mm
Pins: 2 ~ 60
Types: SMT/DIP,
S/T & D/R

Applications

DSC
PDA
Mobile phone
Notebook



PalCONN, the Interconnect Division of Palpilot International, has developed a new series of Wire to Board (WTB) connectors that fit applications requiring high-power solutions or microminiature options.

The connectors are available in multiple pitch size ranging from 0.6 mm to 2.54 mm.

All connectors meet industry standard performance specs and many are RoHS compliant.

For standard product details, please refer to online data sheets, or contact PalCONN below.



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